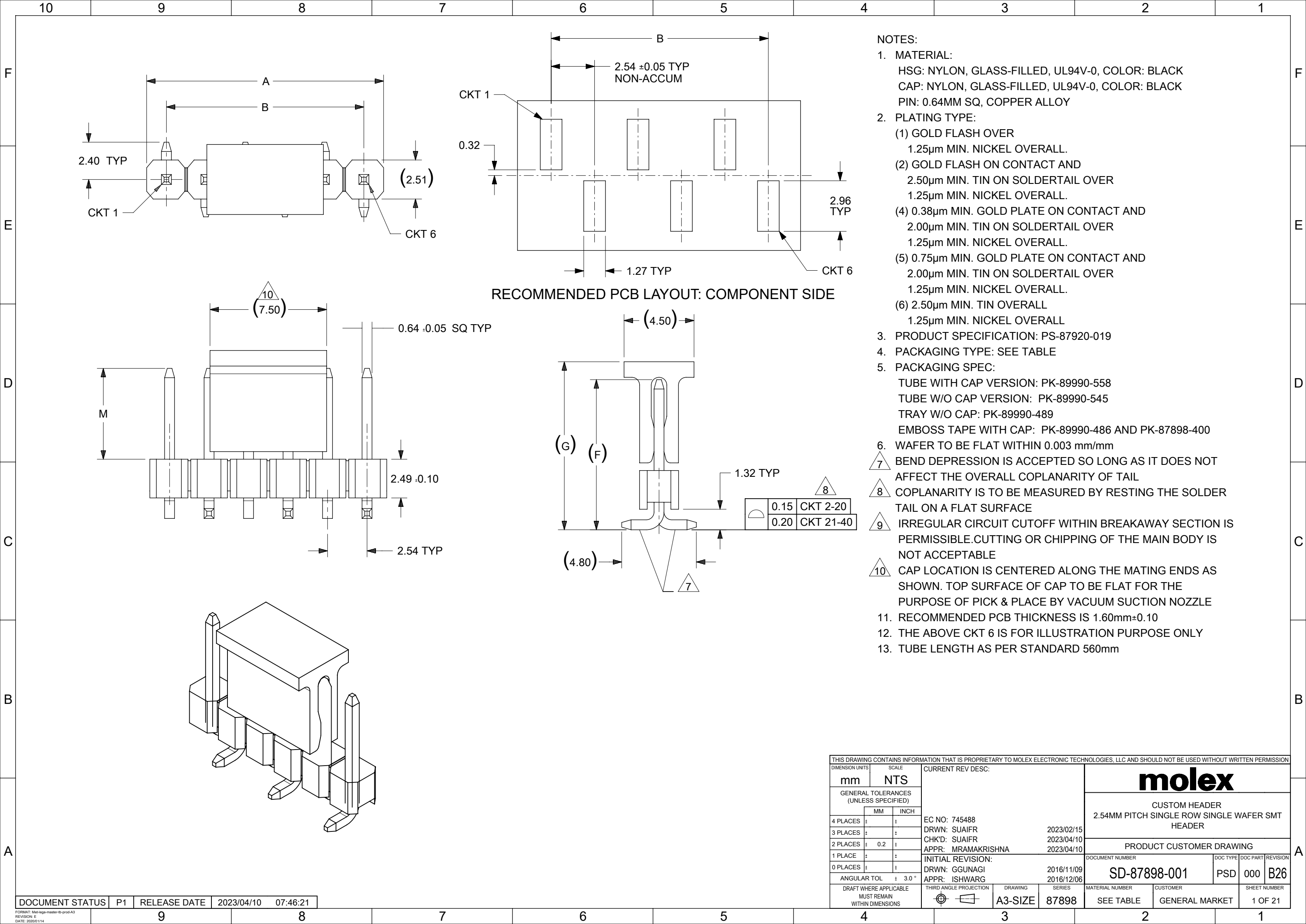




- NOTES:
- MATERIAL:
HSG: NYLON, GLASS-FILLED, UL94V-0, COLOR: BLACK
CAP: NYLON, GLASS-FILLED, UL94V-0, COLOR: BLACK
PIN: 0.64MM SQ, COPPER ALLOY
 - PLATING TYPE:
(1) GOLD FLASH OVER
1.25µm MIN. NICKEL OVERALL.
(2) GOLD FLASH ON CONTACT AND
2.50µm MIN. TIN ON SOLDER TAIL OVER
1.25µm MIN. NICKEL OVERALL.
(4) 0.38µm MIN. GOLD PLATE ON CONTACT AND
2.00µm MIN. TIN ON SOLDER TAIL OVER
1.25µm MIN. NICKEL OVERALL.
(5) 0.75µm MIN. GOLD PLATE ON CONTACT AND
2.00µm MIN. TIN ON SOLDER TAIL OVER
1.25µm MIN. NICKEL OVERALL.
(6) 2.50µm MIN. TIN OVERALL
1.25µm MIN. NICKEL OVERALL
 - PRODUCT SPECIFICATION: PS-87920-019
 - PACKAGING TYPE: SEE TABLE
 - PACKAGING SPEC:
TUBE WITH CAP VERSION: PK-89990-558
TUBE W/O CAP VERSION: PK-89990-545
TRAY W/O CAP: PK-89990-489
EMBOSS TAPE WITH CAP: PK-89990-486 AND PK-87898-400
 - WAFER TO BE FLAT WITHIN 0.003 mm/mm
 - BEND DEPRESSION IS ACCEPTED SO LONG AS IT DOES NOT AFFECT THE OVERALL COPLANARITY OF TAIL
 - COPLANARITY IS TO BE MEASURED BY RESTING THE SOLDER TAIL ON A FLAT SURFACE
 - IRREGULAR CIRCUIT CUTOFF WITHIN BREAKAWAY SECTION IS PERMISSIBLE. CUTTING OR CHIPPING OF THE MAIN BODY IS NOT ACCEPTABLE
 - CAP LOCATION IS CENTERED ALONG THE MATING ENDS AS SHOWN. TOP SURFACE OF CAP TO BE FLAT FOR THE PURPOSE OF PICK & PLACE BY VACUUM SUCTION NOZZLE
 - RECOMMENDED PCB THICKNESS IS 1.60mm±0.10
 - THE ABOVE CKT 6 IS FOR ILLUSTRATION PURPOSE ONLY
 - TUBE LENGTH AS PER STANDARD 560mm

THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX ELECTRONIC TECHNOLOGIES, LLC AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION													
DIMENSION UNITS		SCALE		CURRENT REV DESC:				molex					
mm		NTS											
GENERAL TOLERANCES (UNLESS SPECIFIED)								CUSTOM HEADER 2.54MM PITCH SINGLE ROW SINGLE WAFER SMT HEADER					
								PRODUCT CUSTOMER DRAWING					
4 PLACES	±												

